





#### P-CHANNEL ENHANCEMENT MODE MOSFET

## **Product Summary**

BV <sub>DSS</sub>	R <sub>DS(ON)</sub>	I <sub>D</sub> T <sub>A</sub> = +25°C
-20V	$28m\Omega @ V_{GS} = -4.5V$	-8A
-20 V	$43m\Omega$ @ V <sub>GS</sub> = -2.5V	-6.8A

## **Description and Applications**

This MOSFET is designed to minimize the on-state resistance (R<sub>DS(ON)</sub>) yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

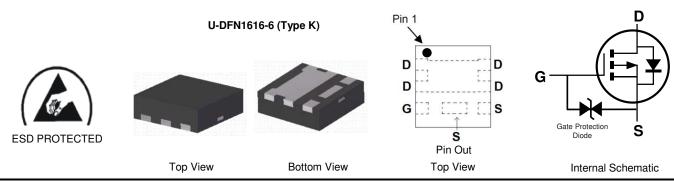
Load Switch

### **Features**

- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- ESD Protected Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

### **Mechanical Data**

- Case: U-DFN1616-6
- Case Material: Molded Plastic, "Green" Molding Compound.
   UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (4)
- Weight: 0.003 grams (Approximate)



### Ordering Information (Note 4)

Part Number	Case	Packaging
DMP2037UFCL-7	U-DFN1616-6 (Type K)	3,000 / Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.



# **Marking Information**

### U-DFN1616-6 (Type K)

**OE** YWX OE = Product Type Marking Code YWX = Date Code Marking

Y = Year (ex: 1 = 2021)

W = Week (ex: a = Week 27; z Represents Week 52 and 53) X = Internal Code (ex: U = Monday)

Date Code Key

Year	2020	2021	2022	2023	2024	2025	2026	2027	2028	2029	2030	2031
Code	0	1	2	3	4	5	6	7	8	9	0	1

Week	1-26	27-52	53
Code	A-Z	a-z	Z

Internal Code	Sun	Mon	Tue	Wed	Thu	Fri	Sat
Code	Т	U	V	W	Χ	Υ	Z



# **Maximum Ratings** (@ $T_A = +25^{\circ}C$ , unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage		V <sub>DSS</sub>	-20	V
Gate-Source Voltage	Vgss	±10	V	
Continuous Drain Current (Note 7) V <sub>GS</sub> = -4.5V $ T_{A} = +25^{\circ}C $ $ T_{A} = +70^{\circ}C $		lο	-8 -6	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)		I <sub>DM</sub>	-45	Α
Maximum Continuous Body Diode Forward Current (Note 6)	ls	-3.1	Α	
Avalanche Current, L = 0.1mH (Note 8)	las	-8	Α	
Avalanche Energy, L = 0.1mH (Note 8)		Eas	7	mJ

# **Thermal Characteristics**

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)		PD	1.1	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	RθJA	114	°C/W
Total Power Dissipation (Note 6)		PD	2.3	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	RθJA	55	00/14/
Thermal Resistance, Junction to Case (Note 7)		R <sub>0</sub> JC	8.7	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

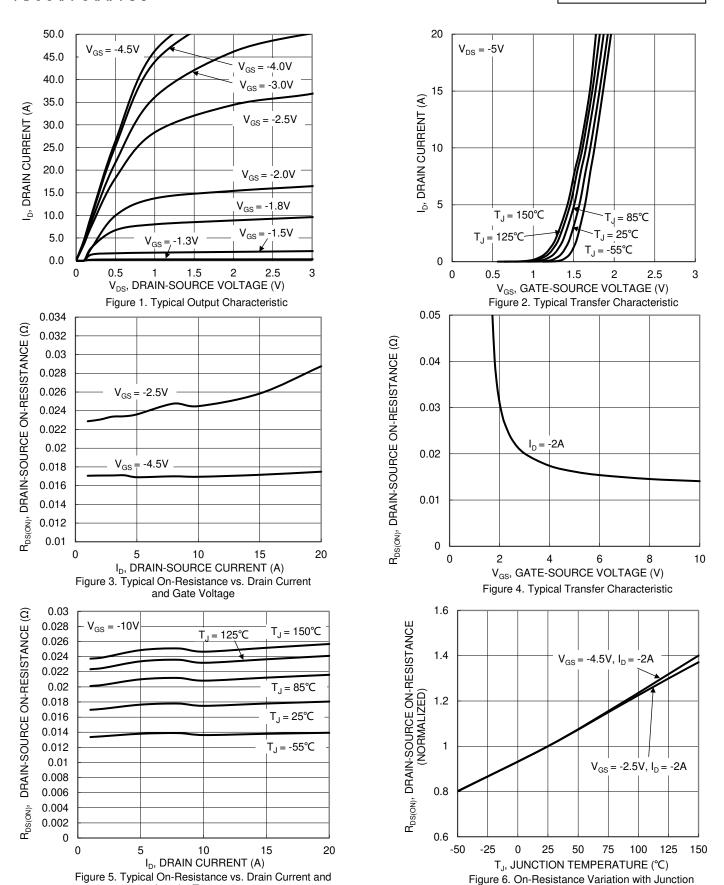
### Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 9)						
Drain-Source Breakdown Voltage	BVDSS	-20	_		V	$V_{GS} = 0V$ , $I_{D} = -1mA$
Zero Gate Voltage Drain Current	IDSS	_	_	-1	μΑ	V <sub>DS</sub> = -16V, V <sub>GS</sub> = 0V
Gate-Source Leakage	Igss	_	_	±10	μA	$V_{GS} = \pm 8V$ , $V_{DS} = 0V$
ON CHARACTERISTICS (Note 9)						
Gate Threshold Voltage	V <sub>GS(TH)</sub>	-0.5	_	-1.5	V	$V_{DS} = V_{GS}$ , $I_D = -250\mu A$
Static Drain-Source On-Resistance	Provenu.	_	17	28	mΩ	$V_{GS} = -4.5V, I_D = -2A$
Static Drain-Source On-Nesistance	R <sub>DS(ON)</sub>	_	23	43	11122	$V_{GS} = -2.5V$ , $I_{D} = -2A$
Diode Forward Voltage	$V_{SD}$	_	-0.7	-1.1	V	$V_{GS} = 0V$ , $I_{S} = -1A$
DYNAMIC CHARACTERISTICS (Note 10)						
Input Capacitance	Ciss	_	806	_		101/11/
Output Capacitance	Coss	_	119	_	pF	$V_{DS} = -10V$ , $V_{GS} = 0V$ f = 1MHz
Reverse Transfer Capacitance	Crss	_	55	_		I = IIVIFIZ
Gate Resistance	Rg	_	81	_	Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$
Total Gate Charge (V <sub>GS</sub> = -8V)	Qg		16.5	_		
Total Gate Charge (VGS = -4.5V)	Qg	_	8.5	_	20	\/ 10\/ In 20A
Gate-Source Charge	Qgs	_	4.2	_	nC	$V_{DD} = -10V, I_{D} = -20A$
Gate-Drain Charge	Qgd		0.5	_		
Turn-On Delay Time	td(on)	_	13	_		
Turn-On Rise Time	t <sub>R</sub>	_	6	_	ns	$V_{GS} = -4.5V, V_{DD} = -10V,$
Turn-Off Delay Time	tD(OFF)	_	110	_	115	$R_G = 1\Omega$ , $R_G = 1\Omega$ , $I_D = -10A$
Turn-Off Fall Time	t <sub>F</sub>		38	_		

Notes:

- 5. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.
  6. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.
- 7. Thermal resistance from junction to soldering point (on the exposed drain pad). 8. las and Eas ratings are based on low frequency and duty cycles to keep  $T_{\rm J}=25^{\circ}C$ .
- 9. Short duration pulse test used to minimize self-heating effect.
- 10. Guaranteed by design. Not subject to product testing.

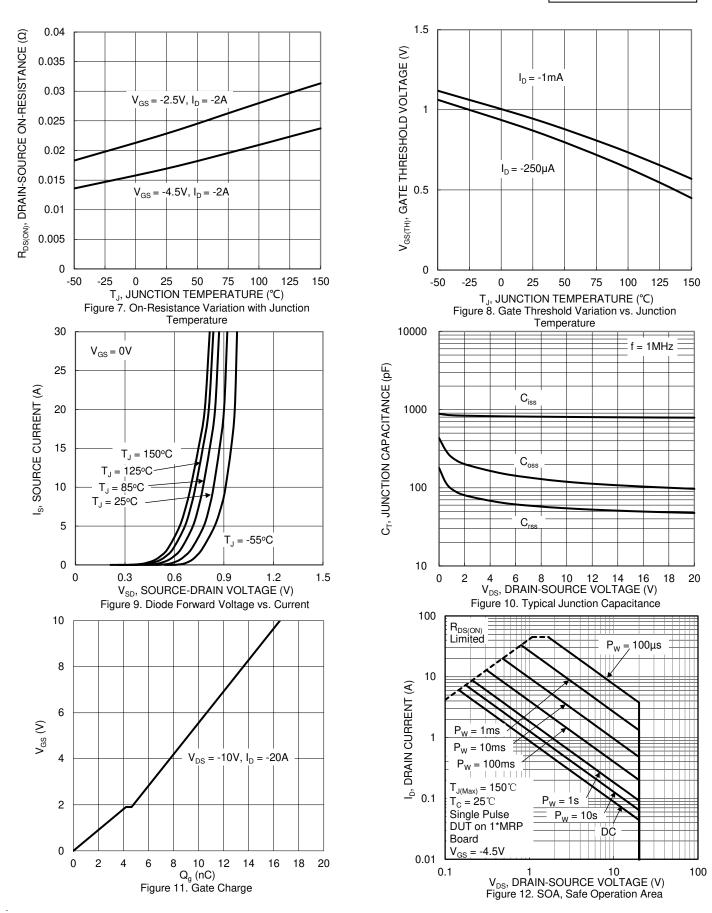




JunctionTemperature

Temperature







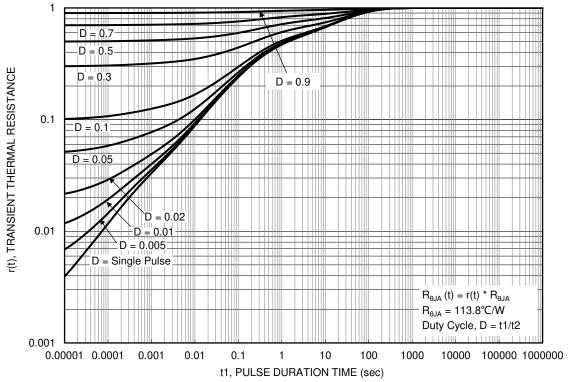


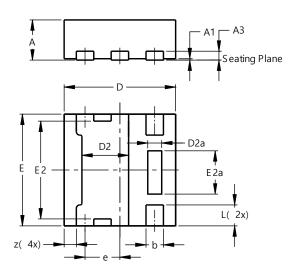
Figure 13. Transient Thermal Resistance



# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### U-DFN1616-6 (Type K)

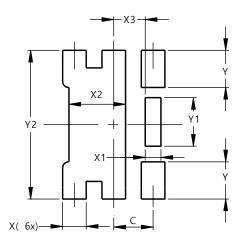


	U-DFN1616-6 (Type K)						
Dim	Min	Max	Тур				
Α	0.55	0.60	0.575				
A1	0.00	0.05	0.02				
A3			0.13				
b	0.20	0.30	0.25				
D	1.55	1.65	1.60				
D2	0.57	0.77	0.67				
D2a	0.10	0.30	0.20				
е	-		0.50				
Е	1.55	1.65	1.60				
E2	1.30	1.50	1.40				
E2a	0.52	0.72	0.62				
L	0.25	0.35	0.30				
Z			0.175				
All	All Dimensions in mm						

## **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### U-DFN1616-6 (Type K)



Dimensions	Value
פווטופוופווט	(in mm)
C	0.500
X	0.300
X1	0.200
X2	0.720
Х3	0.400
Υ	0.475
Y1	0.620
Y2	1.900



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